WHAT IS CLAIMED IS:

- A system for detecting asperities on a disc surface, the system comprising:
 - a glide head, wherein the glide head has an air bearing surface with a peak-to-valley flatness less than about 1 µinch;
 - an armature for positioning the glide head over the disc; and
 - a transducer mounted on the glide head, the transducer detecting interactions between the glide head and the disc.
- 2. The asperity detection system of claim 1 wherein the glide head is cut from a wafer having a wafer surface and the air bearing surface comprises a portion of the wafer surface.
- 3. The asperity detection system of claim 1 wherein the glide head is cat from a wafer and a side face of the glide head substantially perpendicular to the air bearing surface comprises a cut face.
- 4. A glide head comprising an air bearing surface having a surface flatness less than about 1 µinch and a transducer that produces a signal in response to contact with the glide head.
- 5. The glide head of claim 4 wherein said air bearing surface includes rails.
- 6. The glide head of claim 4 wherein the transducer comprises a PZT transducer mounted on a

surface opposite the air bearing surface.

- 7. The glide head of claim 6 wherein the PZT transducer is mounted above the air bearing surface.
- 8. The glide head of claim 6 wherein the PZT transducer is mounted on a wing.
- 9. The glide head of claim 4 wherein the transducer comprises a thermal transducer mounted on the air pearing surface.
- 10. The glide head of claim 4 wherein the air bearing surface has a flatness less than about 0.5 μ inch.

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11. A wafer having a surface contoured for the air bearing surfaces of a plurality of glide heads.

The wafer of claim 11 wherein the air bearing surface comprise rails.

- 13. The wafer of claim 11 wherein said contoured surface has a flatness less than about 3 um.
- 14. The wafer of claim 11 wherein the wafer comprises aluminum oxide/titanium carbide.

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